

Silicon Step Recovery Diodes

Rev. V2

Features

- Output Combs to 40+ GHz
- Transition Times down to 35 ps
- Screening per MIL-PRF-19500 and MIL-PRF-38534 available



The diodes feature fully passivated, true mesa construction for sharp transitions and improved stability. The beam lead SRDs have the industry's fastest transition times for millimeter wave multiplication and picoseconds pulse forming.



Ceramic Microwave Pill Ceramic Epoxy SMT Ceramic Hermetic SMT



Chip & Beam Lead Electrical Specifications: T_A = 25°C

Model	Voltage Breakdown (V _B)	Capac	ction citance C _J)	Lifetime (t)		Transition Time (t _t)		Frequency Cutoff (Fco)	Theta (θ _{JC})
	V	pF		ns		ps		GHz	°C/W
	Min.	Min.	Max.	Min.	Тур.	Тур.	Max.	Тур.	Max.
Chip									
MMD805-C12	60	2.5	3.5	80	100	250	300	130	15
MMD810-C12	50	1.5	2.5	40	70	200	250	200	22
MMD820-C12	40	1.0	1.7	30	60	80	100	390	25
MMD830-C11	25	0.5	1.0	15	30	60	80	700	45
MMD832-C11	20	0.4	0.8	10	15	60	80	660	50
MMD835-C11	15	0.3	0.7	10	20	60	70	800	60
MMD837-C11	20	0.2	0.4	5	10	60	70	1300	60
MMD840-C11	15	0.2	0.4	7	15	60	70	880	60
Beam Lead									
MMDB30-B11	14	0.15	0.25	1	4	30	38	530	600
MMDB35-B11	16	0.13	0.20	1	4	35	45	482	600
MMDB45-B11	25	0.11	0.20	3	8	45	58	410	600

Test Conditions:

 V_B : I_R = 10 μA C_J : V_R = 6 V, 1 MHz

t: $I_F = 10 \text{ mA}$, $I_R = 6 \text{ mA} @ 50\%$ Recovery

 t_i : for Chip: $I_F = 10$ mA, $V_R = 10$ V t_i : for Beam Lead: $I_F = 3$ mA, $V_R = 7$ V

It. 101 Beath Lead. IF = 3 IIIA, V

 F_{CO} : $1/2\pi R_S$

1



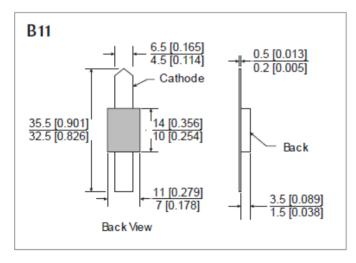
Silicon Step Recovery Diodes

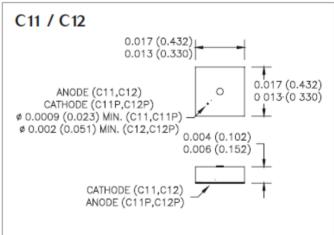
Rev. V2

Absolute Maximum Ratings

Parameters	Rating
Reverse Voltage	Rated V _{BR}
Forward Current	Chip = 150 mA Beam Lead = 50 mA
CW Power Dissipation	150°C / θ _{JC} @ +25°C, derate linearly to zero @ T _{HSK} = +175°C
Operating / Storage Temperature	-65°C to +175°C
Mounting / Bonding Temperature	Chip = +310°C for 30 seconds Beam Lead = +235°C for 10 seconds

Chip & Beam Lead Outline Drawings







Silicon Step Recovery Diodes

Rev. V2

Ceramic Packaged Electrical Specifications: T_A = 25°C

Model	Voltage Breakdown (V _B)	eakdown Capacitance			time t)	Transition Time (t _t)		Package
	٧	р	F	r	ıs	ps		
	Min.	Min.	Max.	Min.	Тур.	Тур.	Max.	
		2.57	3.57					E25
		2.58	3.58	80				E28 / 28X
MMD805-	60	2.68	3.68		100	250	300	H20
IVIIVIDOUS-	00	2.68	3.68	80	100	250	300	T86
		2.75	3.75					T89
		2.56	3.56					0805-2
		1.58	2.58			200	250	E28 / 28X
MMD810-	50	1.68	2.68	3 40	70			H20
IVIIVIDO IU-	50	1.68	2.68					T86
		1.75	2.75					T89
	40	1.08	1.78	30	60			E28 / 28X
MMD820-		1.18	1.88			80	100	H20
IVIIVIDOZU-		1.18	1.88			00	100	T86
		1.06	1.76					0805-2
		0.58	1.08				80	E28 / 28X
MMD830-	25	0.68	1.18	15	30	60		H20
IVIIVIDO30-	25	0.68	1.18	15	30		00	T86
		0.56	1.06					0805-2
		0.48	0.88					E28 / 28X
MMD832-	20	0.58	0.98	10	45	60	80	H20
IVIIVIDO32-	20	0.58	0.98	10	15	00		T86
		0.46	0.86					0805-2
		0.38	0.88					E28 / 28X
MMD835-	15	0.42	0.92	10	20	50	70	H20
-60סחואוואו	10	0.48	0.98	10	20	50	70	T86
		0.36	0.86					0805-2

Test Conditions:

 V_B : I_R = 10 μ A

 C_T : $V_R = 6 \dot{V}$, 1 MHz

t: I_F = 10 mA, I_R = 6 mA @ 50% Recovery

 t_t : for MMD805 - MMD840: I_F = 10 mA, V_R = 10 V

 t_t : for MMDB30 - MMDB45: I_F = 3 mA, V_R = 7 V

(Continued next page)



Silicon Step Recovery Diodes

Rev. V2

Ceramic Packaged Electrical Specifications: T_A = 25°C

Model	Voltage Breakdown (V _B)	Capac	otal citance C⊤)		time t)	Ti	sition me t _t)	Package
	V	pF		ns		ps		
	Min.	Min.	Max.	Min.	Тур.	Тур.	Max.	
		0.28	0.48	5				E28 / 28X
MMD837-	20	0.32	0.52		10	50	70	H27
IVIIVIDO37-	20	0.38	0.58		10		70	T86
		0.26	0.46					805-2
		0.28	0.48	7	15	50	70	E28 / 28X
MMD040	15	0.32	0.52					H27
MMD840-		0.38	0.58					T86
		0.26	0.46					0805-2
		0.23	0.33					E28 / 28X
MMDB30-	14	0.20	0.30	1	4	30	38	0402
		0.21	0.31					0805-2
		0.21	0.28				45	E28 / 28X
MMDB35-	16	0.18	0.22	1	4	35		0402
		0.19	0.26					0805-2
		0.19	0.28					E28 / 28X
MMDB45-	25	0.16	0.25	3	8	45	58	0402
		0.17	0.26					0805-2

Test Conditions:

 V_B : I_R = 10 μA

 C_T : V_R = 6 V, 1 MHz

t: I_F = 10 mA, I_R = 6 mA @ 50% Recovery

 t_t : for MMD805 - MMD840: I_F = 10 mA, V_R = 10 V

 t_t : for MMDB30 - MMDB45: I_F = 3 mA, V_R = 7 V

Absolute Maximum Ratings

Parameters	Rating			
Reverse Voltage	Rated V _{BR}			
Forward Current	MMD = 150 mA MMDB = 50 mA			
Operating / Storage Temperature	-65°C to +175°C			
Mounting / Bonding Temperature	+260°C peak per JEDEC J-STD-20C			

4

MACOM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice.

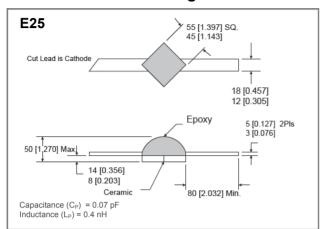
Visit www.macom.com for additional data sheets and product information.

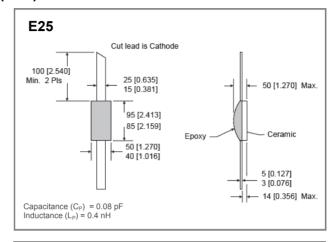


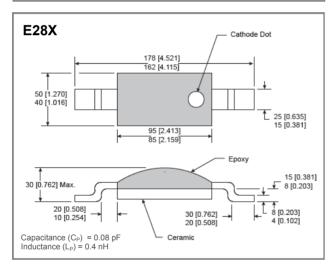
Silicon Step Recovery Diodes

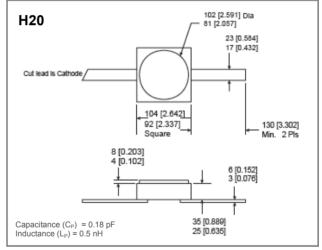
Rev. V2

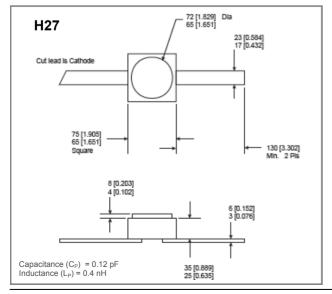
Ceramic Outline Drawings: Dimension = mils (mm)











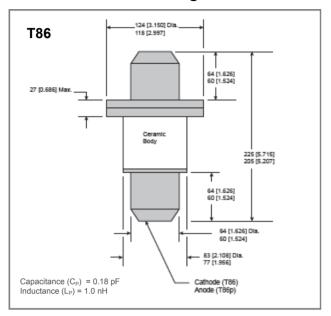
(Continued next page)

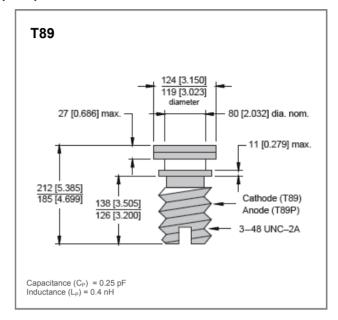


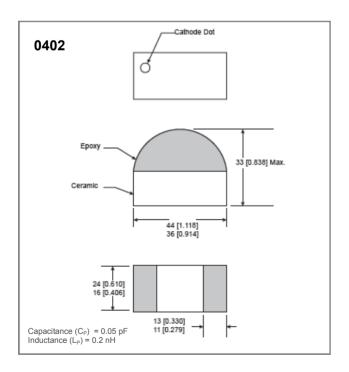
Silicon Step Recovery Diodes

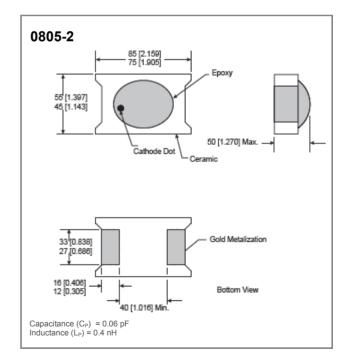
Rev. V2

Ceramic Outline Drawings: Dimension = mils (mm)











Silicon Step Recovery Diodes

Rev. V2

Glass Packaged Electrical Specifications: T_A = 25°C

Model # (-package)	Voltage Breakdown (V _B)	Total Capacitance (C _T)		reakdown Capacitance (t)		Trans Tii (1	Package	
	V	р	pF		ns		ps	
	Min.	Тур.	Max.	Min.	Тур.	Тур.	Max.	
MMD0151-	15	0.70	0.80	10	15	100	_	
MMD0153-	25	0.45	0.55	10	15	95	_	
MMD0803-	70	4.15	6.15	200	250	275	400	
MMD0815-	50	3.15	4.15	100	135	180	320	A15
MMD0825-	45	1.15	2.15	30	50	130	160	
MMD0833-	25	1.75	1.80	10	15	90	_	
MMD0840-	15	0.60	0.75	10	20	75	_	

Test Conditions:

 $V_B: I_R = 10 \mu A$

 C_T : for MMD0151 & MMD0153: V_R = 6 V, 1 MHz

 C_T : for MMD0803 - MMD0840: V_R = 10 V, 1 MHz

t: $I_F = 10 \text{ mA}$, $I_R = 6 \text{ mA} @ 50\%$ Recovery

 t_t : for MMD0803 - MMD0825: I_F = 10 mA, V_R = 10 V

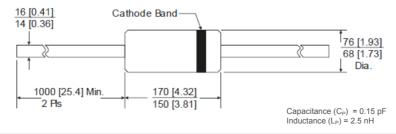
tt: for MMD0151, MMD0153, MMD0833, MMD0840: chip data packaged limits to 100 ps

Absolute Maximum Ratings

Parameters	Rating		
Reverse Voltage	Rated V _{BR}		
Forward Current	100 mA		
Thermal Resistance, Junction to Case	+600°C/W		
Operating / Storage Temperature	-65°C to +200°C		
Mounting / Bonding Temperature	+230°C for 10 seconds		

Glass Outline Drawing

A15



7

MACOM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice.

Visit www.macom.com for additional data sheets and product information.



Silicon Step Recovery Diodes

Rev. V2

Plastic Packaged Electrical Specifications: T_A = 25°C

Model	Voltage Breakdown (V _B)			Lifetime (t)		Transition Time (t _t)		Package	
	V	р	F	r	ns	F	os		
	Min.	Min.	Max.	Min.	Тур.	Тур.	Max.		
SMMD805-	60	2.5	3.5	80	100	250	300	SOT23 (-0S, -1S)	
			0.0					SOD323	
SMMD810-	50	1.5	2.5	40	70	200	250	SOT23 (-0S, -1S)	
SIVIIVIDO 10-	30	1.5	2.5	40	70	200	230	SOD323	
SMMD820-	40	1.0	1.7	30	60	110	125	SOT23 (-0S, -1S)	
SIVIIVID620-	40	1.0	1.7	30	00	110	125	SOD323	
SMMD830-	25	0.5	1.0	15	30	90	440	110	SOT23 (-0S, -1S)
SIVIIVID630-	23	0.5	1.0	15	30	90	110	SOD323	
SMMD832-	20	0.4	0.8	10	20	85	100	SOT23 (-0S, -1S)	
SIVIIVID632-	20	0.4	0.6	10	20	83	100	SOD323	
SMMD835-	20	0.3	0.7	10	15	80	100	SOT23 (-0S, -1S)	
SIVIIVID633-	20	0.3	0.7	10	15	80	100	SOD323	
SMMD837	20	0.2	0.4	5	12	75	90	SOT23 (-0S, -1S)	
GIVIIVIDOS7	20	0.2	0.4	5	12	7.5	30	SOD323	
SMMD840-	15	0.2	0.4	5	10	70	90	SOT23 (-0S, -1S)	
SIVIIVIDO4U-	10	0.2	U. 4	ິ	10	70	90	SOD323	

Test Conditions:

 $V_B: I_R = 10 \, \mu A$

 $C_J: V_R = 6 \dot{V}, 1 MHz$

t: I_F = 10 mA, I_R = 6 mA @ 50% Recovery

 $t_t:I_F = 10 \text{ mA}, V_R = 10 \text{ V}$

Absolute Maximum Ratings

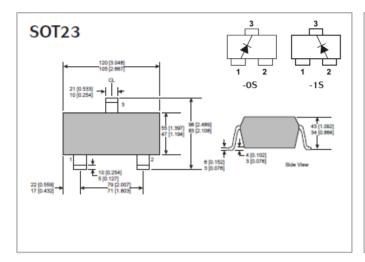
Parameters	Rating			
Reverse Voltage	Rated V _{BR}			
Forward Current	100 mA			
Power Dissipation	250 mW, derate linearly to zero @ T_A = +150°C			
Operating / Storage Temperature	-65°C to +150°C			
Mounting / Bonding Temperature	+260°C peak per JEDEC J-STD-20C			

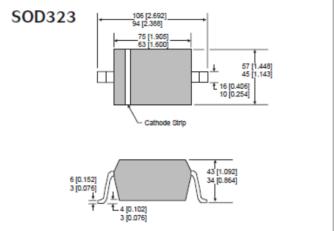


Silicon Step Recovery Diodes

Rev. V2

Plastic Outline Drawings





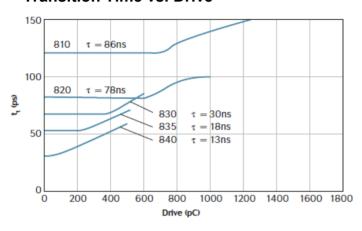


Silicon Step Recovery Diodes

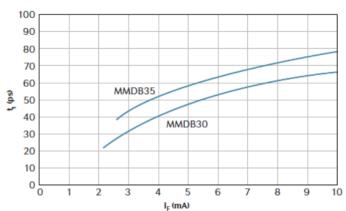
Rev. V2

Typical Performance Curves: $T_A = 25^{\circ}C$

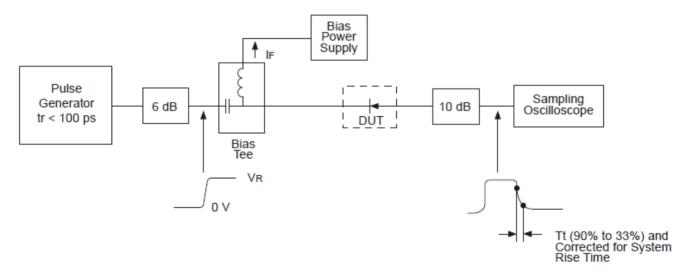
Transition Time vs. Drive



Transition Time vs. Forward Current



Transition Time Test Circuit





Silicon Step Recovery Diodes

Rev. V2

MACOM Technology Solutions Inc. All rights reserved.

Information in this document is provided in connection with MACOM Technology Solutions Inc ("MACOM") products. These materials are provided by MACOM as a service to its customers and may be used for informational purposes only. Except as provided in MACOM's Terms and Conditions of Sale for such products or in any separate agreement related to this document, MACOM assumes no liability whatsoever. MACOM assumes no responsibility for errors or omissions in these materials. MACOM may make changes to specifications and product descriptions at any time, without notice. MACOM makes no commitment to update the information and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to its specifications and product descriptions. No license, express or implied, by estoppels or otherwise, to any intellectual property rights is granted by this document.

THESE MATERIALS ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, EITHER EXPRESS OR IMPLIED, RELATING TO SALE AND/OR USE OF MACOM PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, CONSEQUENTIAL OR INCIDENTAL DAMAGES, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT. MACOM FURTHER DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. MACOM SHALL NOT BE LIABLE FOR ANY SPECIAL, INDIRECT, INCIDENTAL, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS, WHICH MAY RESULT FROM THE USE OF THESE MATERIALS.

MACOM products are not intended for use in medical, lifesaving or life sustaining applications. MACOM customers using or selling MACOM products for use in such applications do so at their own risk and agree to fully indemnify MACOM for any damages resulting from such improper use or sale.